

PA-1650-88D2 SPECIAL ASSEMBLING INSTRUCTION

REV:A

[illegible]




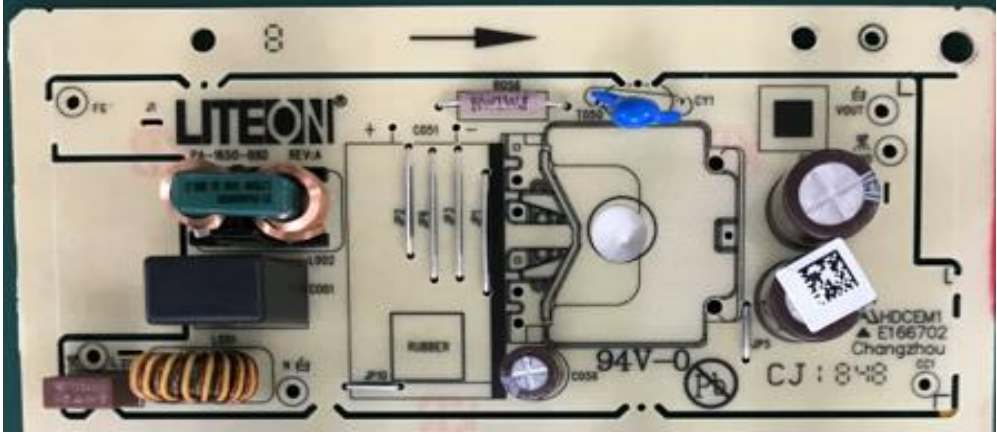
Prepared by: Jacky Tsai

Checked by:

Approved by:

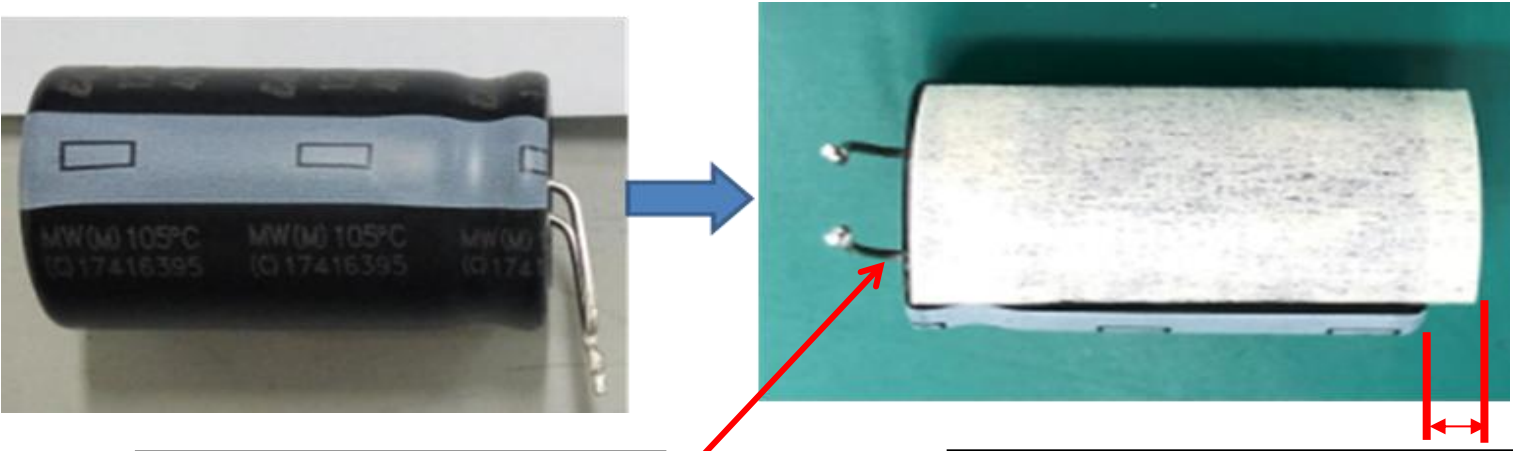
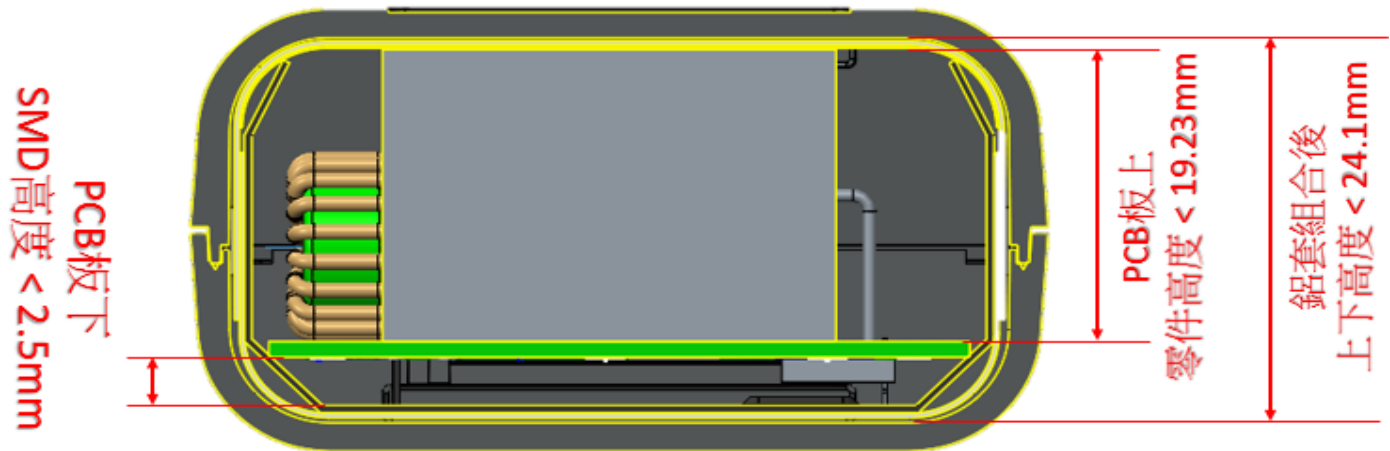
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APPENDIX

		REMARK
<div data-bbox="322 257 1393 756"></div>		<div data-bbox="1433 484 1618 534">點738351膠</div>
<p>圖A</p>		
<div data-bbox="318 814 1558 1310"></div> <div data-bbox="206 1324 584 1369">D050、Q050 需完全被膠覆蓋</div> <div data-bbox="988 1316 1254 1360">工廠首件確認時卡</div> <div data-bbox="1300 1324 1558 1369">Q300至少覆蓋一半</div>		
<div data-bbox="349 1408 1327 1808"></div>		<div data-bbox="1407 1408 1588 1456">點738351膠</div> <div data-bbox="1379 1660 1598 1705">膠不可覆蓋LED</div>
<p>圖B</p>		
<div data-bbox="347 1920 1345 2352"></div>		<div data-bbox="1407 2108 1572 2153">點738351膠</div>
<p>圖C</p>		

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APPENDIX

				REMARK
<div><div></div><div>圖D</div></div>				
Componet Limit Height				
NO.	Name	C001 Dimension	C051 Dimension	T050 Dimension
H1	Adaptor height	28.00	28.00	28.00
1	Case top	1.80	1.80	1.80
1.1	Assembly Tolerance(Main body<->case Top)	0.20	0.20	0.20
2	Shielding TOP	0.30	0.00	0.30
2.1	Tape	0.12	0.12	0.12
3	Glue	0.00	0.10	0.20
4	PCB	1.00	1.00	1.00
4.1	C051 BTM Wire	0.00	0.70	0.00
4.2	C051 BTM Tape	0.00	0.30	0.00
5	Trimming free gap	2.50	2.50	2.50
6	FRPP	0.45	0.45	0.45
6.1	Tolerance(FRPP <-> Shielding BTM)	0.10	0.10	0.10
7	Shielding BTM	0.30	0.30	0.30
8	Component Height (MAX)	19.00	18.50	18.90
9.1	Assembly Tolerance(Main body<->case btm)	0.20	0.20	0.20
9	Case Btm	1.80	1.80	1.80
	Thickness TTL	23.77	24.07	23.87
	Component Limit Height (MAX)		19.23	
<div></div> <div>圖E</div>				